

Title (en)

Method of depositing a wear-resistant coating by thermal spraying

Title (de)

Verfahren zur Abscheidung einer Verschleißschutzschicht durch thermisches Spritzen

Title (fr)

Procédé de dépôt par projection thermique d'un revêtement anti-usure

Publication

EP 1705261 A1 20060927 (FR)

Application

EP 06111543 A 20060322

Priority

FR 0502865 A 20050323

Abstract (en)

Thermal projection of a copper/nickel/indium alloy as an anti-wear coating on a mechanical part is effected by an Activated Combustion High Velocity Air Fuel (AC-HVAF) process.

IPC 8 full level

C23C 4/12 (2006.01); **C23C 4/08** (2006.01); **F01D 5/28** (2006.01)

CPC (source: EP US)

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F05D 2300/1723 (2013.01 - EP US)

Citation (applicant)

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Citation (search report)

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DOCDB simple family (application)

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